

XPT IGBT Module

preliminary

$$V_{CES} = 1200 \text{ V}$$

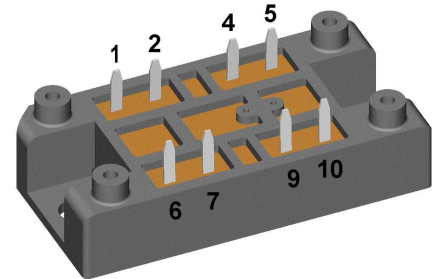
$$I_{C25} = 250 \text{ A}$$

$$V_{CE(sat)} = 1.7 \text{ V}$$

Boost Chopper

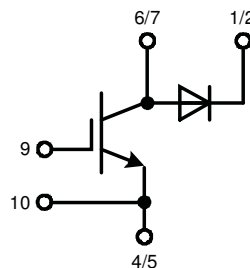
Part number

MIXA150R1200VA



Backside: isolated

 E72873



Features / Advantages:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
 - short circuit rated for 10 μ sec.
 - very low gate charge
 - low EMI
 - square RBSOA @ 3x I_c
- Thin wafer technology combined with the XPT design results in a competitive low $V_{CE(sat)}$
- SONIC™ diode
 - fast and soft reverse recovery
 - low operating forward voltage

Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

Package: V1-A-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Terms .Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments;

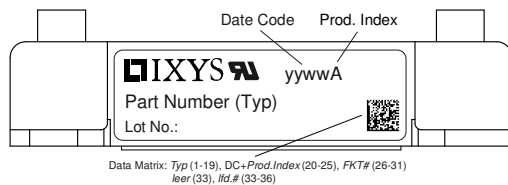
- the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IGBT				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V_{CES}	collector emitter voltage	$T_{VJ} = 25^{\circ}\text{C}$				1200	V
V_{GES}	max. DC gate voltage					± 20	V
V_{GEM}	max. transient gate emitter voltage					± 30	V
I_{C25}	collector current	$T_C = 25^{\circ}\text{C}$				250	A
I_{C80}		$T_C = 80^{\circ}\text{C}$				175	A
P_{tot}	total power dissipation	$T_C = 25^{\circ}\text{C}$				695	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 150\text{A}; V_{GE} = 15\text{V}$	$T_{VJ} = 25^{\circ}\text{C}$		1.7	2.1	V
			$T_{VJ} = 125^{\circ}\text{C}$		1.9		V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 6\text{mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^{\circ}\text{C}$	6	6.8	7.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{V}$	$T_{VJ} = 25^{\circ}\text{C}$			0.1	mA
			$T_{VJ} = 125^{\circ}\text{C}$		0.1		mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20\text{V}$				500	nA
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{V}; V_{GE} = 15\text{V}; I_C = 150\text{A}$			510		nC
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{V}; I_C = 150\text{A}$ $V_{GE} = \pm 15\text{V}; R_G = 1.2\Omega$	$T_{VJ} = 125^{\circ}\text{C}$		220		ns
t_r	current rise time				100		ns
$t_{d(off)}$	turn-off delay time				400		ns
t_f	current fall time				220		ns
E_{on}	turn-on energy per pulse				21.5		mJ
E_{off}	turn-off energy per pulse				17		mJ
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15\text{V}; R_G = 1.2\Omega$	$T_{VJ} = 125^{\circ}\text{C}$				
I_{CM}		$V_{CEmax} = 1200\text{V}$				450	A
SCSOA	short circuit safe operating area	$V_{CEmax} = 1200\text{V}$					
t_{SC}	short circuit duration	$V_{CE} = 900\text{V}; V_{GE} = \pm 15\text{V}$	$T_{VJ} = 125^{\circ}\text{C}$			10	μs
I_{SC}	short circuit current	$R_G = 1.2\Omega$; non-repetitive			650		A
R_{thJC}	thermal resistance junction to case					0.16	K/W
R_{thCH}	thermal resistance case to heatsink				0.10		K/W
Diode							
V_{RRM}	max. repetitive reverse voltage		$T_{VJ} = 25^{\circ}\text{C}$			1200	V
I_{F25}	forward current		$T_C = 25^{\circ}\text{C}$			190	A
I_{F80}			$T_C = 80^{\circ}\text{C}$			130	A
V_F	forward voltage	$I_F = 150\text{A}$	$T_{VJ} = 25^{\circ}\text{C}$			2.20	V
			$T_{VJ} = 125^{\circ}\text{C}$		1.95		V
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^{\circ}\text{C}$			0.3	mA
			$T_{VJ} = 125^{\circ}\text{C}$		0.8		mA
Q_{rr}	reverse recovery charge	$V_R = 600\text{V}$ $-di_F/dt = 2500\text{A}/\mu\text{s}$ $I_F = 150\text{A}; V_{GE} = 0\text{V}$	$T_{VJ} = 125^{\circ}\text{C}$		20		μC
I_{RM}	max. reverse recovery current				175		A
t_{rr}	reverse recovery time				350		ns
E_{rec}	reverse recovery energy				10		mJ
R_{thJC}	thermal resistance junction to case					0.28	K/W
R_{thCH}	thermal resistance case to heatsink				0.20		K/W

preliminary

Package V1-A-Pack				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal				100	A
T_{VJ}	virtual junction temperature			-40		150	°C
T_{op}	operation temperature			-40		125	°C
T_{stg}	storage temperature			-40		125	°C
Weight					37		g
M_D	mounting torque			2		2.5	Nm
$d_{Spp/App}$	creepage distance on surface / striking distance through air		terminal to terminal	6.0			mm
$d_{Spb/Apb}$			terminal to backside	12.0			mm
V_{ISOL}	isolation voltage	t = 1 second	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3600			V
		t = 1 minute		3000			V



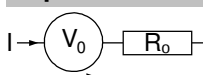
Part description

M = Module
 I = IGBT
 X = XPT IGBT
 A = Gen 1 / std
 150 = Current Rating [A]
 R = Boost Chopper
 1200 = Reverse Voltage [V]
 VA = V1-A-Pack

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MIXA150R1200VA	MIXA150R1200VA	Blister	24	511595

Equivalent Circuits for Simulation

* on die level

 $T_{VJ} = 150^\circ\text{C}$  $V_{0\max}$ threshold voltage $R_{0\max}$ slope resistance *

IGBT

Diode

1.1

1.25

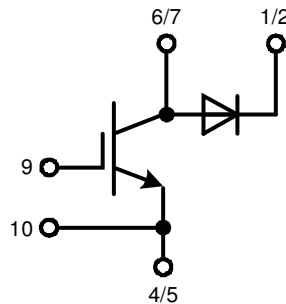
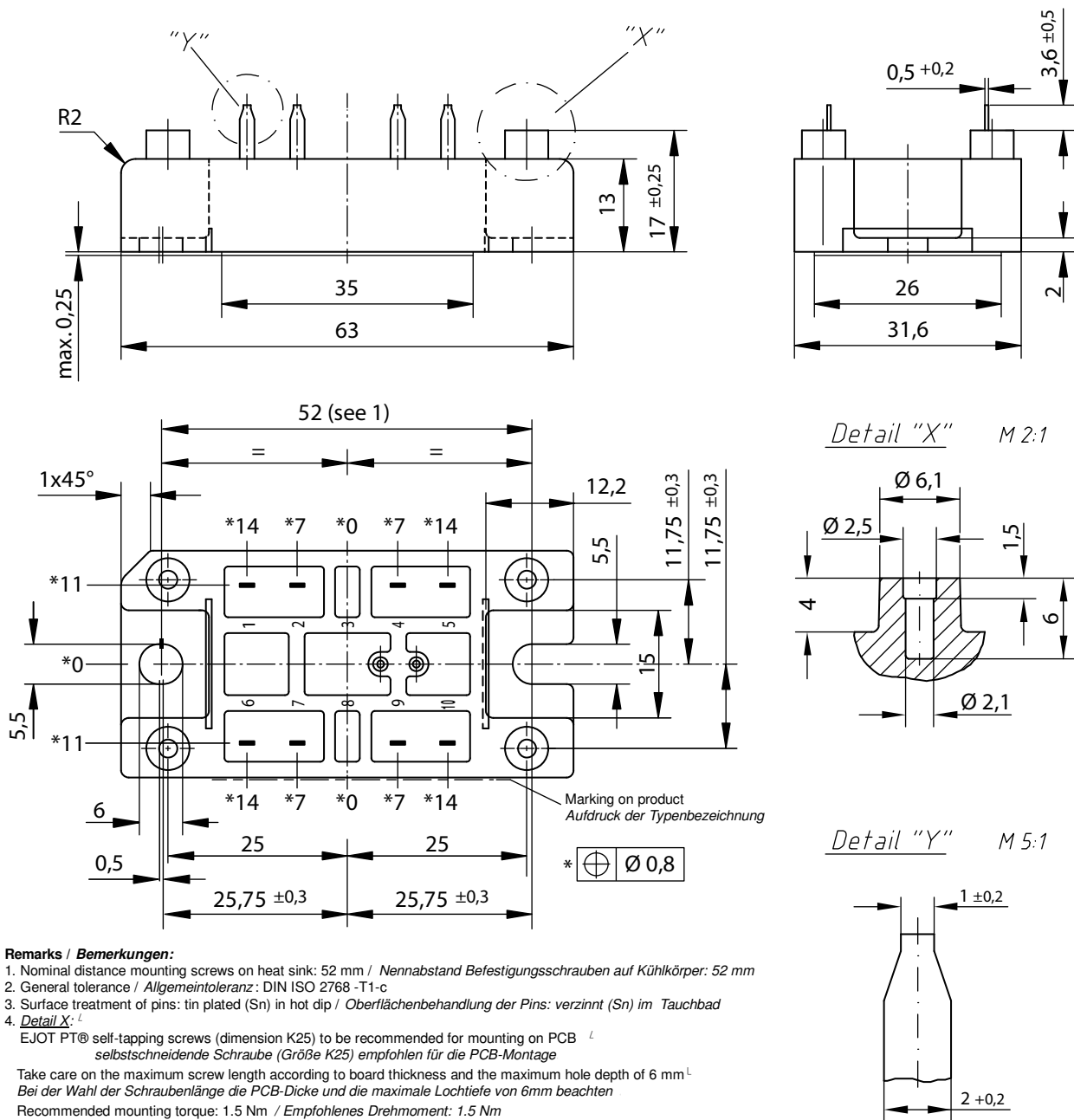
V

9.2

5.7

mΩ

Outlines V1-A-Pack



IGBT

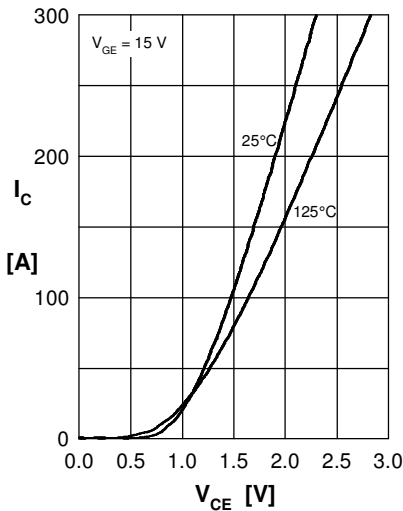


Fig.1 Output characteristics IGBT

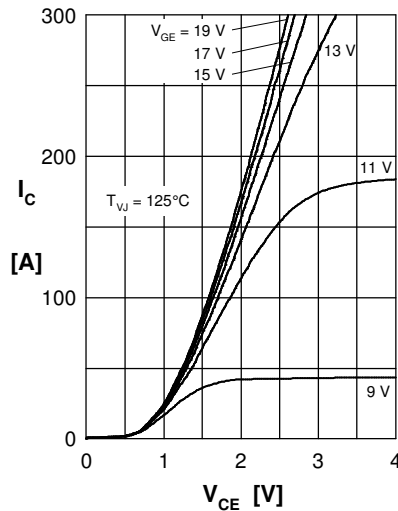


Fig.2 Typ. output characteristics IGBT

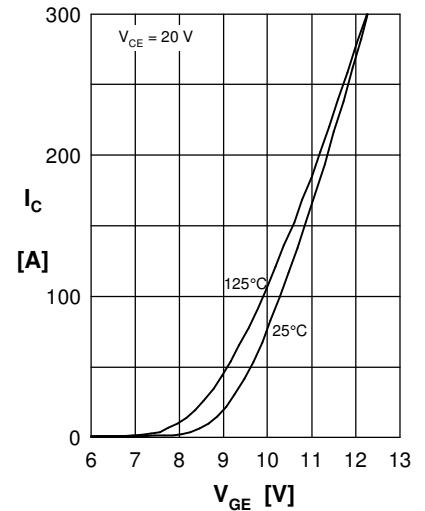


Fig.3 Typ. transfer charact. IGBT

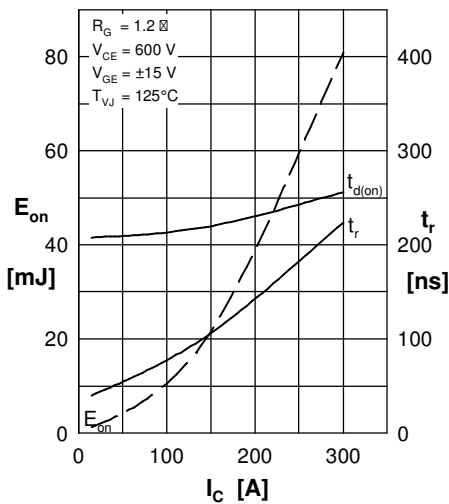


Fig.4 Typ. turn-on energy & switch. times vs. collector current

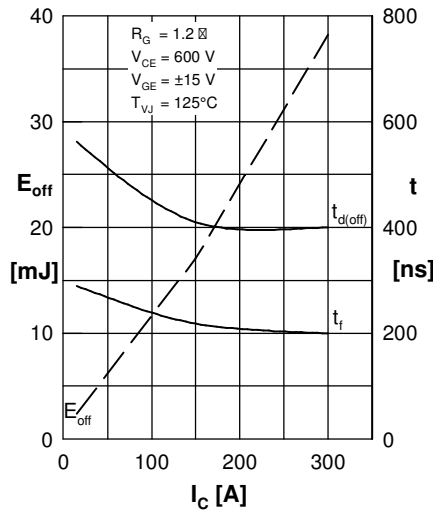


Fig.5 Typ. turn-off energy & switch. times vs. collector current

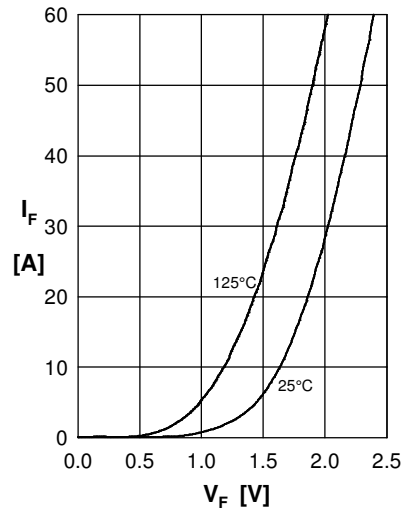


Fig.6 Typ. forward characteristics Diode

Fig.7 Typ. reverse recovery characteristics Diode

Fig.8 Typ. reverse recovery characteristics Diode

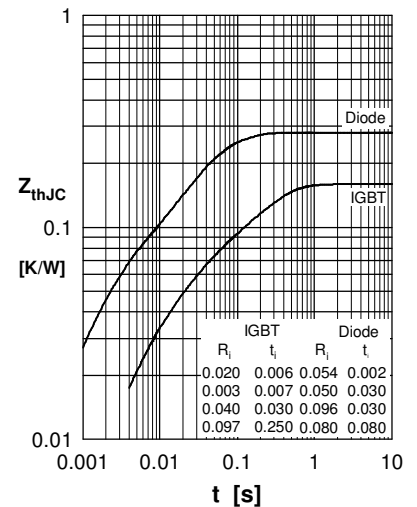


Fig.9 Transient thermal resistance junction to case